

|                                   |  |                         |                                         |             |
|-----------------------------------|--|-------------------------|-----------------------------------------|-------------|
| <b>Notice of References Cited</b> |  | Application/Control No. | Applicant(s)/Patent Under Reexamination |             |
|                                   |  | 09/775,372              | CHEN ET AL.                             |             |
| Examiner                          |  | Art Unit                |                                         | Page 1 of 1 |
| Suresh K Suryawanshi              |  | 2115                    |                                         |             |

**U.S. PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Name              | Classification |
|---|---|--------------------------------------------------|-----------------|-------------------|----------------|
|   | A | US-4,392,021                                     | 07-1983         | Slate, Matthew W. | 380/243        |
|   | B | US-5,986,967                                     | 11-1999         | Furumochi et al.  | 365/233        |
|   | C | US-6,538,489                                     | 03-2003         | Nakano, Hirotaka  | 327/297        |
|   | D | US-4,970,405                                     | 11-1990         | Hagiwara, Misao   | 327/145        |
|   | E | US-4,691,126                                     | 09-1987         | Splett et al.     | 327/526        |
|   | F | US-                                              |                 |                   |                |
|   | G | US-                                              |                 |                   |                |
|   | H | US-                                              |                 |                   |                |
|   | I | US-                                              |                 |                   |                |
|   | J | US-                                              |                 |                   |                |
|   | K | US-                                              |                 |                   |                |
|   | L | US-                                              |                 |                   |                |
|   | M | US-                                              |                 |                   |                |

**FOREIGN PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Country | Name             | Classification |
|---|---|--------------------------------------------------|-----------------|---------|------------------|----------------|
|   | N | JP 03280922 A                                    | 12-1991         | Japan   | KIKUCHI, KATSUYA | A61B 01/04     |
|   | O |                                                  |                 |         |                  |                |
|   | P |                                                  |                 |         |                  |                |
|   | Q |                                                  |                 |         |                  |                |
|   | R |                                                  |                 |         |                  |                |
|   | S |                                                  |                 |         |                  |                |
|   | T |                                                  |                 |         |                  |                |

**NON-PATENT DOCUMENTS**

|   |   |                                                                                                   |
|---|---|---------------------------------------------------------------------------------------------------|
| * |   | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)         |
|   | U | IBM, Bypass Selection Mechanism For Defective Chips, 11/01/1979, Vol 22, Issue 6, pages 2301-2302 |
|   | V |                                                                                                   |
|   | W |                                                                                                   |
|   | X |                                                                                                   |

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.